

ANALOG Wideband 4 GHz, 43 dB Isolation at 1 GHz, DEVICES CMOS 1.65 V to 2.75 V, 2:1 Mux/SPDT Switches

力 材 料 886-3-5753170

ADG918/ADG919

FEATURES

Wideband switch: -3 dB @ 4 GHz 胜特力电子(上海) 86-21-34970699 Absorptive/reflective switches 胜特力电子(深圳) 86-755-83298787 High off isolation (43 dB @ 1 GHz) Http://www. 100y. com. tw Low insertion loss (0.8 dB @1 GHz) Single 1.65 V to 2.75 V power supply **CMOS/LVTTL** control logic 8-lead MSOP and tiny 3 mm × 3 mm LFCSP packages Low power consumption (<1 μ A)

APPLICATIONS

Wireless communications **General-purpose RF switching Dual-band applications** High speed filter selection Digital transceiver front end switch IF switching **Tuner modules** Antenna diversity switching

GENERAL DESCRIPTION

The ADG918/ADG919 are wideband switches using a CMOS process to provide high isolation and low insertion loss to 1 GHz. The ADG918 is an absorptive (matched) switch having 50 Ω terminated shunt legs, while the ADG919 is a reflective switch. These devices are designed such that the isolation is high over the dc to 1 GHz frequency range. They have on-board CMOS control logic, thus eliminating the need for external controlling circuitry. The control inputs are both CMOS and

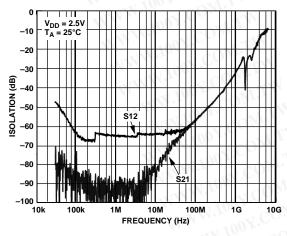
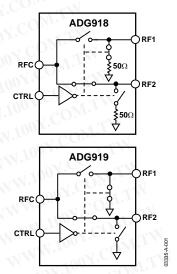


Figure 2. Off Isolation vs. Frequency

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FUNCTIONAL BLOCK DIAGRAMS



LVTTL compatible. The low power consumption of these CMOS devices makes them ideally suited to wireless applications and general-purpose high frequency switching.

PRODUCT HIGHLIGHTS

- 1. -43 dB Off Isolation @ 1 GHz.
- 2. 0.8 dB Insertion Loss @ 1 GHz.
- 3. Tiny 8-Lead MSOP/LFCSP Packages

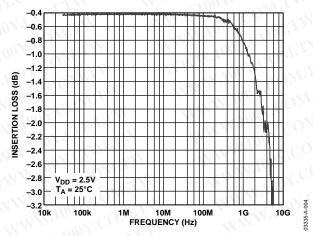


Figure 3. Insertion Loss vs. Frequency

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REVISION HISTORY

9/04—Changed from Rev. 0 to Rev. A

REVISION HISTORY	
9/04—Changed from Rev. 0 to Rev. A	
Updated FormatUniversal	
Change to Data Sheet Title	
Change to Features	
Change to Product Highlights1	
Changes to Specifications	
Change to ADG9xx Evaluation Board section	
Changes to Ordering Guide14	
8/03 Revision 0: Initial Version	

SPECIFICATIONS

Table 1. V_{DD} = 1.65 V to 2.75 V, GND = 0 V, input power = 0 dBm, all specifications T_{MIN} to T_{MAX}, unless otherwise noted.¹

W.TW W. 1003	COM.	W.1002	$0_{M_{1}}$	B Version		
Parameter	Symbol	Conditions	Min	Typ²	Max	Unit
AC ELECTRICAL CHARACTERISTICS	V.COm	TW WWW. 100Y.	17	W		
Operating Frequency ³	-1 CON	WWW.Io	DC		2	GHz
3 dB Frequency⁴	101.	W.I.M. M	MOD		4	GHz
Input Power ⁴	OOY.CO	0 V dc Bias	Y.Co		7	dBm
	of C	0.5 V dc Bias	V.COD		16	dBm
Insertion Loss	S ₂₁ , S ₁₂	DC to 100 MHz; $V_{DD} = 2.5 \text{ V} \pm 10\%$	-1 CO	0.4	0.7	dB
	100Y.	500 MHz; $V_{DD} = 2.5 \text{ V} \pm 10\%$	001.	0.5	8.0	dB
	N.L.	1000 MHz; $V_{DD} = 2.5 \text{ V} \pm 10\%$	any.C	0.8	1.25	dB
Isolation—RFC to RF1/RF2	S ₂₁ , S ₁₂	100 MHz	57	60		dB
(CP Package)	100	500 MHz	46	49		dB
	1111	1000 MHz	36	43		dB
Isolation—RFC to RF1/RF2	S ₂₁ , S ₁₂	100 MHz	55	60		dB
(RM Package)	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	500 MHz	43	47		dB
NW. CO. TW	MM	1000 MHz	34	37		dB
Isolation—RF1 to RF2 (Crosstalk)	S ₂₁ , S ₁₂	100 MHz	55	58		
(CP Package)	NA.	500 MHz	41	44		
NW W 100X.CO	MM.	1000 MHz	31	37		
Isolation—RF1 to RF2 (Crosstalk)	S ₂₁ , S ₁₂	100 MHz	54	57		
(RM Package)	321/ 312	500 MHz	39	42		
THE TOTAL STATE OF THE PARTY.		1000 MHz	31	33		
Return Loss (On Channel) ⁴	S ₁₁ , S ₂₂	DC to 100 MHz	21	27		dB
neturi 2033 (Ori Charmer)	311, 322	500 MHz	22	27		dB
		1000 MHz	22	26		dB
Return Loss (Off Channel) ⁴	S ₁₁ , S ₂₂	DC to 100 MHz	18	23		dB
ADG918	311, 322	500 MHz	17	21		dB
ADG916		1000 MHz	16	20		dB
On Switching Time ⁴	T.	50% CTRL to 90% RF	10		10	1.1.
Off Switching Time ⁴	ton	50% CTRL to 10% RF	V	6.6 6.5	9.5	ns
Rise Time ⁴	toff		(N)			ns
Fall Time ⁴	trise	10% to 90% RF	1	6.1	9	ns
	trall	90% to 10% RF	CM.	6.1	9 100 Y	ns
1 dB Compression⁴	P _{-1 dB}	1000 MHz	2011	17		dBm
Third Order Intermodulation Intercept	IP ₃	900 MHz/901 MHz, 4 dBm	30	36		dBm
Video Feedthrough ⁵	TI	MM, 100X.Co	TY	2.5	100	mV p-p
DC ELECTRICAL CHARACTERISTICS	OM	N. SANNAN CO	WIL			ON.CO
Input High Voltage	V _{INH}	$V_{DD} = 2.25 \text{ V to } 2.75 \text{ V}$	1.7			V
WW 100X	V _{INH}	$V_{DD} = 1.65 \text{ V to } 1.95 \text{ V}$	0.65 V _{CC}		M	V
Input Low Voltage	V _{INL}	$V_{DD} = 2.25 \text{ V to } 2.75 \text{ V}$	T		0.7	VOY.
WW.100	V _{INL}	$V_{DD} = 1.65 \text{ V to } 1.95 \text{ V}$	CO_{Mr}	CXX	0.35 V _{CC}	V
Input Leakage Current	l _t	$0 \le V_{IN} \le 2.75 \text{ V}$	Mon	± 0.1	±1	μΑ
CAPACITANCE ⁴	WY.CO	TW WW 100	LUCAN			N 100
RF1/RF2, RF Port On Capacitance	C _{RF} ON	f = 1 MHz	A'COM,	1.6		pF
CTRL Input Capacitance	C _{CTRL}	f = 1 MHz	CO1	2	<u> </u>	pF
POWER REQUIREMENTS	100 Y.C	THE WALL	07.	MITW	111	-1XV.1
V_{DD}	.V.	COM. TAN MAN.	1.65		2.75	V
Quiescent Power Supply Current	I _{DD}	Digital inputs = 0 V or V _{DD}	*1 C	0.1	1	μΑ

¹Temperature range B Version: -40°C to +85°C.

Temperature range version. -4 C to 3 C. Typical values are at $V_{DD} = 2.5$ V and 25°C, unless otherwise stated. 3 Point at which insertion loss degrades by 1 dB. 4 Guaranteed by design, not subject to production test. 5 The dc

⁵The dc transience at the output of any port of the switch when the control voltage is switched from high to low or low to high in a 50 Ω test setup, measured with 1 ns rise time pulses and 500 MHz bandwidth.

ABSOLUTE MAXIMUM RATINGS¹

Table 2. (T_A = 25°C, unless otherwise noted.)

Parameter	Rating
V _{DD} to GND	-0.5 V to +4 V
Inputs to GND	$-0.5 \text{ V to V}_{DD} + 0.3 \text{ V}^2$
Continuous Current	30 mA
Input Power	18 dBm
Operating Temperature Range	1100Y.
Industrial (B Version)	-40°C to +85°C
Storage Temperature Range	-65°C to +150°C
Junction Temperature	150°C
MSOP Package	W. 1007.Co
θ_{JA} Thermal Impedance	206°C/W
LFCSP Package	TANNITOO TICO
θ_{JA} Thermal Impedance (2-layer board)	84°C/W
θ_{JA} Thermal Impedance (4-layer board)	48°C/W
Lead Temperature, Soldering (10 sec)	300°C
IR Reflow, Peak Temperature (<20 sec)	235°C
ESD	1 kV

NOTES

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

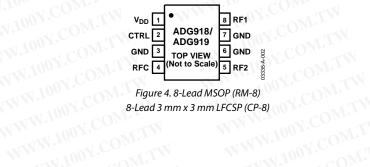
 2 RF1/RF2 Off Port Inputs to Ground -0.5 V to V_{DD} -0.5 V

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



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WWW.100Y.COM.TW Table 3. Truth Table

CTRL	Signal Path
0	RF2 to RFC
N 1	RF1 to RFC

WWW.100Y.COM.TW **Table 4. Pin Function Descriptions**

Pin No.	Mnemonic	Function
1	V_{DD}	Power Supply Input. These parts can be operated from 1.65 V to 2.75 V, and V _{DD} should be decoupled to GND.
2	CTRL	CMOS or TTL Logic Level;
	100 2.	0->RF2 to RFC
	100 Y.Co.	1->RF1 to RFC
3, 6, 7	GND	Ground Reference Point for All Circuitry on the Part
4	RFC	COMMON RF Port for Switch
5	RF2	RF2 Port
8	RF1	RF1 Port

TERMINOLOGY

Parameter	Description
V_{DD}	Most positive power supply potential
I _{DD}	Positive supply current
GND	Ground (0 V) reference
CTRL	Logic control input
V _{INL}	Maximum input voltage for Logic 0
Vinh	Minimum input voltage for Logic 1
I _{INL} (I _{INH})	Input current of the digital input
Cin	Digital input capacitance
ton	Delay between applying the digital control input and the output switching on.
toff	Delay between applying the digital control input and the output switching off.
t rise	Rise time. Time for the RF signal to rise from 10% to 90% of the ON level.
trall	Fall time. Time for the RF signal to fall from 90% to 10% of the ON level.
Off Isolation	The attenuation between input and output ports of the switch when the switch control voltage is in the OFF condition.
Insertion Loss	The attenuation between input and output ports of the switch when the switch control voltage is in the ON condition.
P _{-1 dB}	1 dB compression point. The RF input power level at which the switch insertion loss increases by 1 dB over its low level value. It is a measure of how much power the ON switch can handle before the insertion loss increases by 1 dB.
IP ₃	Third order intermodulation intercept. This is a measure of the power in false tones that occur when closely spaced tone are passed through a switch, whereby the nonlinearity of the switch causes these false tones to be generated.
Return Loss	The amount of reflected power relative to the incident power at a port. Large return loss indicates good matching. By measuring return loss the VSWR can be calculated from conversion charts. VSWR (voltage standing wave ratio) indicates degree of matching present at a switch RF port.
Video Feedthrough	Spurious signals present at the RF ports of the switch when the control voltage is switched from high to low or low to high without an RF signal present.

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TYPICAL PERFORMANCE CHARACTERISTICS

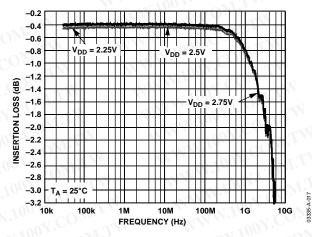


Figure 5. Insertion Loss vs. Frequency over Supplies (RF1/RF2, S12, and S21)

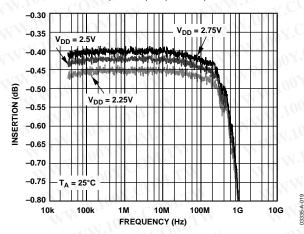


Figure 6. Insertion Loss vs. Frequency over Supplies (RF1/RF2, S12, and S21) (Zoomed Figure 5 Plot)

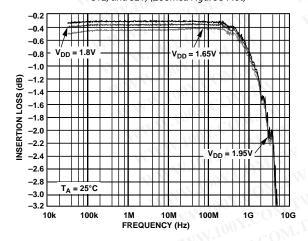


Figure 7. Insertion Loss vs. Frequency over Supplies (RF1/RF2, S12, and S21)

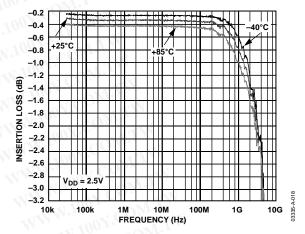


Figure 8. Insertion Loss vs. Frequency over Temperature (RF1/RF2, S12, and S21)

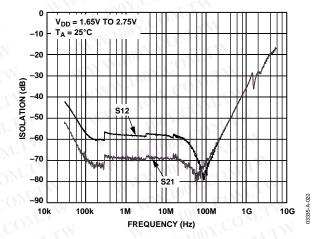


Figure 9. Isolation vs. Frequency over Supplies (RF1/RF2, ADG918)

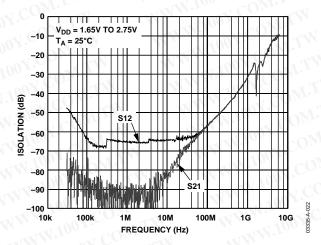


Figure 10. Isolation vs. Frequency over Supplies (RF1/RF2, ADG919)

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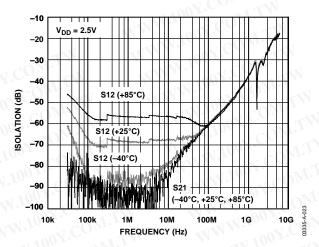


Figure 11. Isolation vs. Frequency over Temperature (RF1/RF2, ADG919)

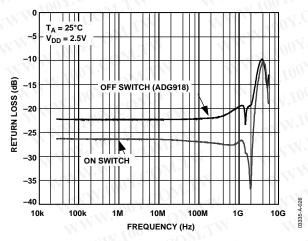


Figure 12. Return Loss vs. Frequency (RF1/RF2, S11)

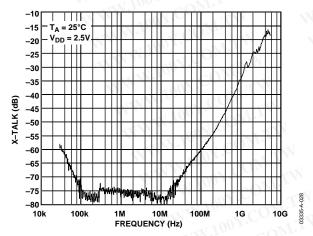


Figure 13. Crosstalk vs. Frequency (RF1/RF2, S12, S21) WWW.100Y.COM.TW

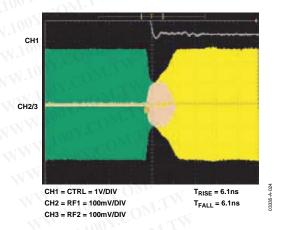


Figure 14. Switch Timing

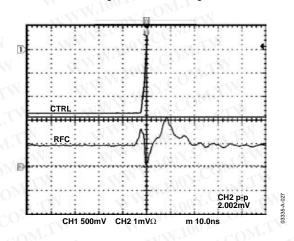


Figure 15. Video Feedthrough

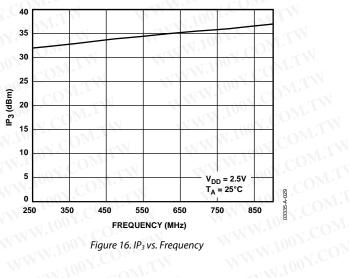
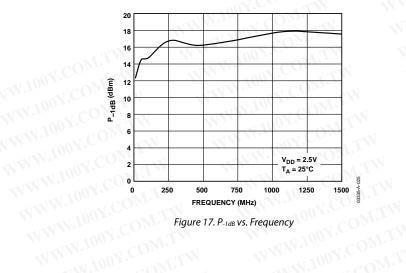


Figure 16. IP₃ vs. Frequency



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TEST CIRCUITS*

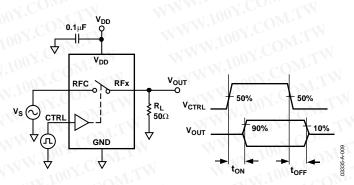


Figure 18. Switch Timing: ton toff

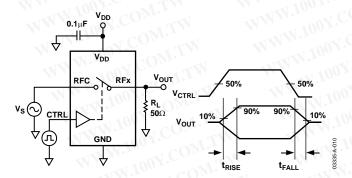


Figure 19. Switch Timing: trise, tfall

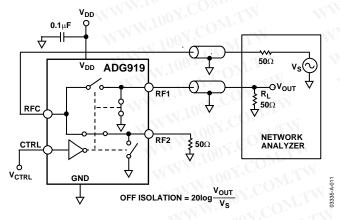


Figure 20. Off Isolation

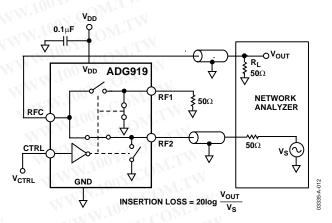


Figure 21. Insertion Loss

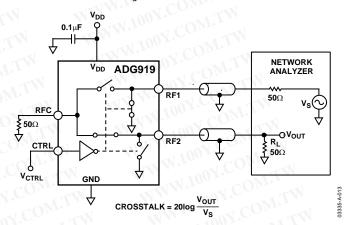


Figure 22. Crosstalk

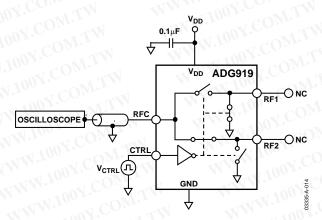
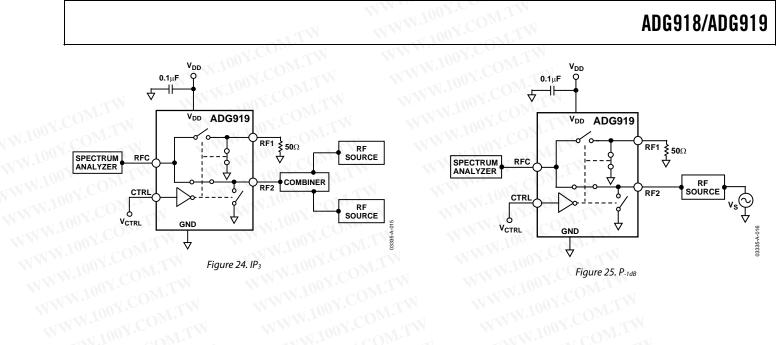


Figure 23. Video Feedthrough



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^{*} Similar setups for ADG918

APPLICATIONS

The ADG918/ADG919 are ideal solutions for low power, high frequency applications. The low insertion loss, high isolation between ports, low distortion, and low current consumption of these parts make them excellent solutions for many high frequency switching applications. The most obvious application is in a transmit/receive block, as shown in the wireless metering block diagram in Figure 26.

Other applications include switching between high frequency filters, ASK generator, FSK generator, and antenna diversity switch in many tuner modules.

ABSORPTIVE VS. REFLECTIVE

The ADG918 is an absorptive (matched) switch with 50 Ω terminated shunt legs, and the ADG919 is a reflective switch with 0 Ω terminated shunts to ground. The ADG918 absorptive switch has a good VSWR on each port, regardless of the switch mode. An absorptive switch should be used when there is a need for a good VSWR that is looking into the port but not passing the through signal to the common port. The ADG918 is therefore ideal for applications that require minimum reflections back to the RF source. It also ensures that the maximum power is transferred to the load.

The ADG919 reflective switch is suitable for applications where high off port VSWR does not matter and the switch has some other desired performance feature. It can be used in many applications, including high speed filter selection. In most cases, an absorptive switch can be used instead of a reflective switch, but not vice versa.

WIRELESS METERING

The ADG918 can be used in wireless metering applications. It can be used in conjunction with the ADF7020 transceiver IC for a utility metering transceiver application, providing the

required isolation between the transmit and receive signals. The SPDT configuration isolates the high frequency receive signal from the high frequency transmit.

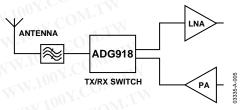


Figure 26. Wireless Metering

TUNER MODULES

The ADG918 can be used in a tuner module to switch between the cable TV input and the off-air antenna.

This part is also ideal for use as an antenna diversity switch, switching different antenna to the tuner.

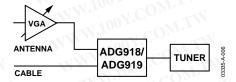


Figure 27. Tuner Modules

FILTER SELECTION

The ADG919 can be used as a 2:1 demultiplex to switch high frequency signals between different filters and also to multiplex the signal to the output.

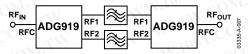


Figure 28. Filter Selection

ADG9XX EVALUATION BOARD

The ADG9xx evaluation board allows designers to evaluate the high performance wideband switches with a minimum of effort.

To prove that these devices meet the user's requirements, the user only requires a power supply and a network analyzer along with the evaluation board. An application note is available with the evaluation board and gives complete information on operating the evaluation board.

The RFC port (see Figure 29) is connected through a 50 Ω transmission line to the top left SMA connector J1. RF1 and RF2 are connected through 50 Ω transmission lines to the top two SMA connectors J2 and J3, respectively. A through transmission line connects J4 and J5 and this transmission line is used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a 4-layer, FR4 material with a dielectric constant of 4.3 and an overall thickness of 0.062 inches. Two ground layers with grounded planes provide ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.052 inches, clearance to ground plane of 0.030 inches, dielectric thickness of 0.029 inches, and a metal thickness of 0.014 inches.

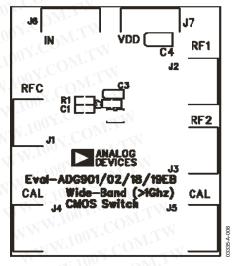
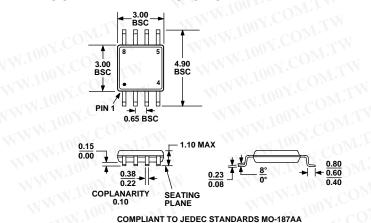


Figure 29, ADG9xx Evaluation Board Top View

OUTLINE DIMENSIONS



W.100Y.COM.TW Figure 30. 8-Lead Mini Small Outline Package [MSOP] WWW.100Y.COM.TW (หM-8) Dimensions shown in millimeters WWW.100Y.COM

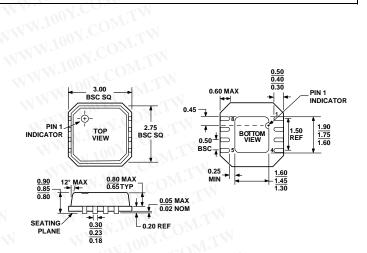


Figure 31. 8-Lead Lead Frame Chip Scale Package [LFCSP] 3 mm x 3 mm Body (CP-8) Dimensions shown in millimeters

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Model	Temperature Range	Package Description	Package Option	Branding
ADG918BRM	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W4B
ADG918BRM-500RL7	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W4B
ADG918BRM-REEL	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W4B
ADG918BRM-REEL7	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W4B
ADG918BRMZ ¹	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W4C
ADG918BRMZ-REEL ¹	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W4C
ADG918BRMZ-REEL7 ¹	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W4C
ADG918BCP-500RL7	-40°C to +85°C	Lead Frame Chip Scale Package (LFCSP)	CP-8	W4B
ADG918BCP-REEL7	-40°C to +85°C	Lead Frame Chip Scale Package (LFCSP)	CP-8	W4B
ADG919BRM	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W5B
ADG919BRM-500RL7	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W5B
ADG919BRM-REEL	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W5B
ADG919BRM-REEL7	-40°C to +85°C	Mini Small Outline Package (MSOP)	RM-8	W5B
ADG919BCP-500RL7	-40°C to +85°C	Lead Frame Chip Scale Package (LFCSP)	CP-8	W5B
ADG919BCP-REEL7	-40°C to +85°C	Lead Frame Chip Scale Package (LFCSP)	CP-8	W5B
EVAL-ADG918EB	W 1 100 1.	Evaluation Board	William	M. Too
EVAL-ADG919EB	MM 1007.	Evaluation Board	ON LIVE	1 100 x.

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¹Z = Pb-free part.

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NOTES

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